

**PATENT ASSIGNMENT**

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Yu-Wei Liu	09/14/2007
Hui-Fen Lin	09/14/2007
Feng-Yuan Gan	09/17/2007
Shu-Chin Lee	09/14/2007
Yen-Heng Huang	09/14/2007
<b>RECEIVING PARTY DATA</b>	
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<b>City:</b>	Hsinchu
<b>State/Country:</b>	TAIWAN
<b>Postal Code:</b>	300, R.O.C.
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	12703926
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**PATENT  
 REEL: 023924 FRAME: 0792**

NAME OF SUBMITTER:

Daniel R. McClure

Total Attachments: 2

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# ASSIGNMENT

WHEREAS, Yu-Wei LIU, Hui-Fen LIN, Feng-Yuan GAN, Shu-Chin LEE,  
and Yen-Heng HUANG

Hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: THIN FILM TRANSISTOR ARRAY SUBSTRATE STRUCTURES AND FABRICATION METHOD THEREOF

Filed: \_\_\_\_\_ Serial No. : \_\_\_\_\_

Executed on: September 14, 2007 and September 17, 2007

WHEREAS, AU Optronics Corp. of No. 1, Li-Hsin Rd. 2, Science-Based Industrial Park, Hsinchu 300, Taiwan (R.O.C.) hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign, and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Yu Wei Liu

Yu-Wei LIU

2007.9.14

Date

Hui-Fen-LIN

Hui-Fen LIN

2007.9.14

Date

AU0512036A/0632-A50688CIP-US

**ASSIGNMENT**



Feng-Yuan GAN

2007. 9. 17

Date

Shu-Chin Lee

Shu-Chin LEE

2007. 9. 14

Date

Yen-Heng Huang

Yen-Heng HUANG

2007. 09. 14.

Date